


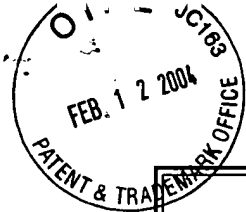


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Electronic Patent Application Submission
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Application ID: 10059745 
Title of Invention: Methods, Apparatus, and
Systems of Fiber Optic Modules,
Elastomeric Connections, and
Retention Mechanisms Therefor
First Named Inventor: Alain Shang
Domestic/Foreign Application: Domestic Application
Filing Date: 2002-03-30
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Title of Invention	Methods, Apparatus, and Systems of Fiber Optic Modules, Elastomeric Connections, and Retention Mechanisms Therefor									
Application Number: 10/059745 										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>William E. Alford Registered Number: 37764</td><td>William E. Alford</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	William E. Alford Registered Number: 37764	William E. Alford	Attorney		
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>3918P003-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	3918P003-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
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	us-ids.dtd									
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Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

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US Patent Documents																																									
<p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p>																																									
<table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>20020093796</td><td>2002-07-18</td><td>Medina,</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>20020150343</td><td>2002-10-17</td><td>Chiu, Liew C., et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>3</td><td>20020167793</td><td>2002-11-14</td><td>Branch, , et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>4</td><td>4217030</td><td>1980-08-12</td><td>Howarth,</td><td></td><td></td><td></td></tr></tbody></table>	init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	20020093796	2002-07-18	Medina,					2	20020150343	2002-10-17	Chiu, Liew C., et al.					3	20020167793	2002-11-14	Branch, , et al.					4	4217030	1980-08-12	Howarth,				
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6	4432604	1984-02-21	Schwab,
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Remarks

Note: Remarks are not for responding to an office action.

Applicants, in accordance with their duty of disclosure under 37 CFR 1.56 and in accordance with 37 CFR 1.97(b)(3), hereby submit this Electronic Information Disclosure Statement citing U.S. Patent Documents for consideration by the Examiner. Pursuant to 37 CFR 1.97, the submission of this Electronic Information Disclosure Statement is not to be construed as a representation that a search has been made and is not to be construed as an admission that the information cited in this statement is

material to patentability. This Electronic Information Disclosure Statement is being filed prior to a substantive examination of the claims. Pursuant to 37 CFR 1.97(b), no fee should be required for the filing of this Electronic Information Disclosure Statement. In the event it is determined that a fee is due, please charge the fee to Deposit Account 02-2666. Applicants respectfully request that the cited documents be considered and that the form be initialed by the Examiner to indicate such consideration and a copy thereof be returned to Applicants' attorney of record.

Signature

Examiner Name	Date